

AF/2826
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2826
Examiner: Fazli Erdem

In re PATENT APPLICATION of

Applicants : Takahiro OKA et al.

Appl. No. : 09/912,064

Filed : July 25, 2001

For : SEMICONDUCTOR CHIP PACKAGE

Atty. Dkt. : TAI 129

AMENDMENT
AFTER FINAL

June 2, 2004

Mail Stop AF

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This Amendment is filed in response to the Examiner's Final Action dated March 2, 2004, the time for response to which is up to and including June 2, 2004. Please amend the above-referenced application as shown on the following pages.

Certification Under 37 C.F.R. §1.8 (if applicable)

I hereby certify that this Amendment is being deposited with the United States Postal Service as First Class Mail under 37 C.F.R. §1.8 on this **June 2, 2004** and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Phillip G. Avruch

Typed or printed name of person
mailing the Amendment

Signature of person mailing the
Amendment

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